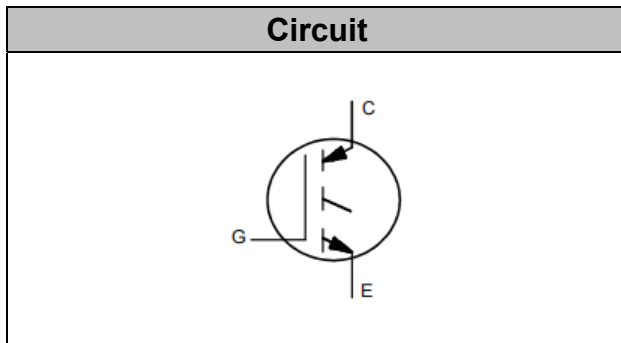


IGBT Discrete

V_{CE}	1200	V
I_C	40	A
$V_{CE(SAT)} I_C=40A$	1.85	V
P_D	625	W



Applications

- PTC heater

Features

- High breakdown voltage to 1200V for improved reliability
- Maximum junction temperature 150
- Positive temperature coefficient
- Qualified to AEC-Q101

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC Collector Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_C	80 40	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage ($t_p \le 10\mu s, D < 0.010$)	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \le 1200V$, $T_j \le 150^{\circ}C$		160	A
Pulsed Collector Current, $V_{GE}=15V$, t_p limited by T_{jmax}	I_{CM}	160	A
Short Circuit Withstand Time, $V_{GE}=15V, V_{CC} 600V V_{CEM} 1200V$	T_{sc}	10	μs
Power Dissipation, $T_j=150^{\circ}C, T_c=25^{\circ}C$	P_{tot}	625	W



Operating Junction Temperature	T_j	-40...+150	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT $T_j = 25$ unless otherwise specified

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=250\mu A$	1200		-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=1.4mA$	4.8	5.6	6.5	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=40A$ $T_j=25^\circ C,$ $T_j=125^\circ C$ $T_j=150^\circ C$		1.85 2.20 2.30	2.40	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$ $T_j=25^\circ C,$ $T_j=150^\circ C$			0.25 5.00	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 30V$			200	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1MHz$	-	2.50	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.09	-	
Gate Charge	Q_G	$V_{CC}=960V, I_C=40A,$ $V_{GE}=15V$	-	0.33	-	uC
Short Circuit Collector Current	I_{SC}	$V_{GE}=15V, t_{sc}\leq 10\mu s,$ $V_{CC}=900V, T_j=150^\circ C$	-	140	-	A

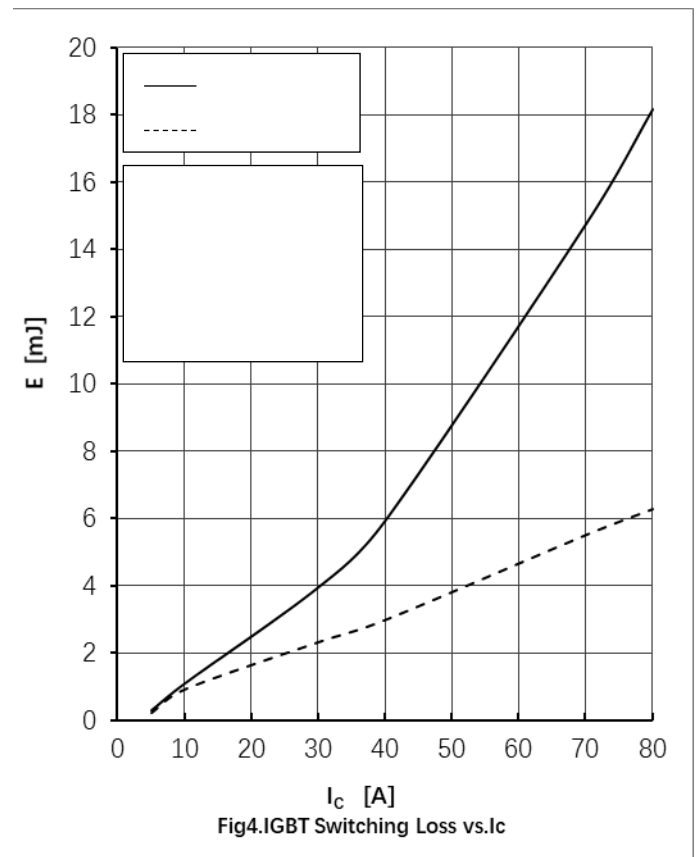
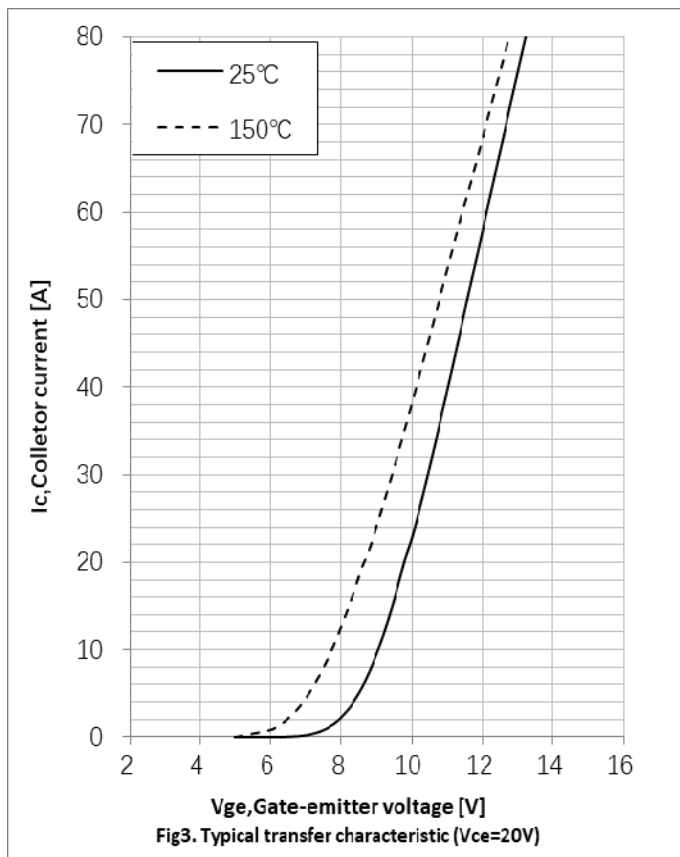
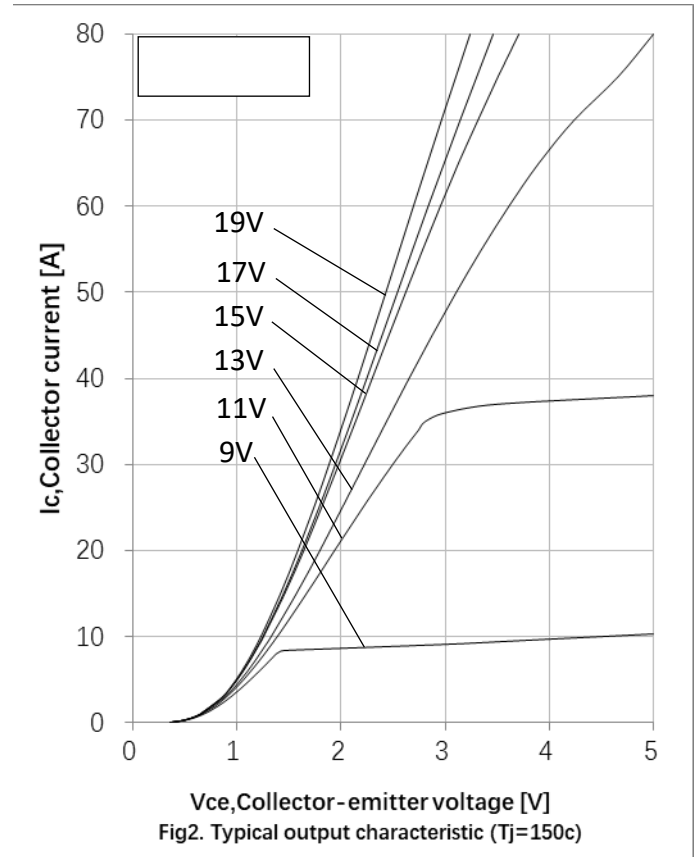
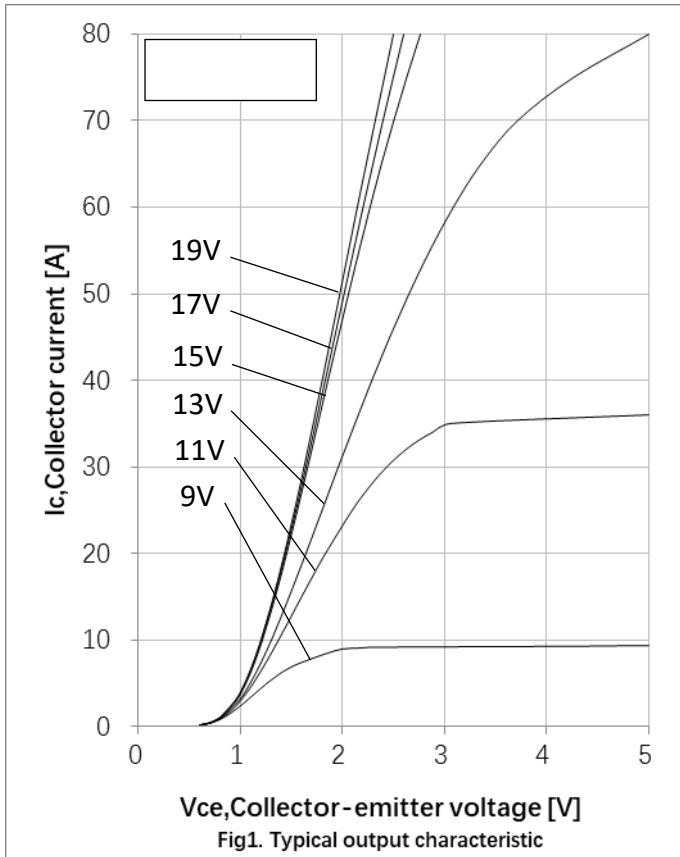


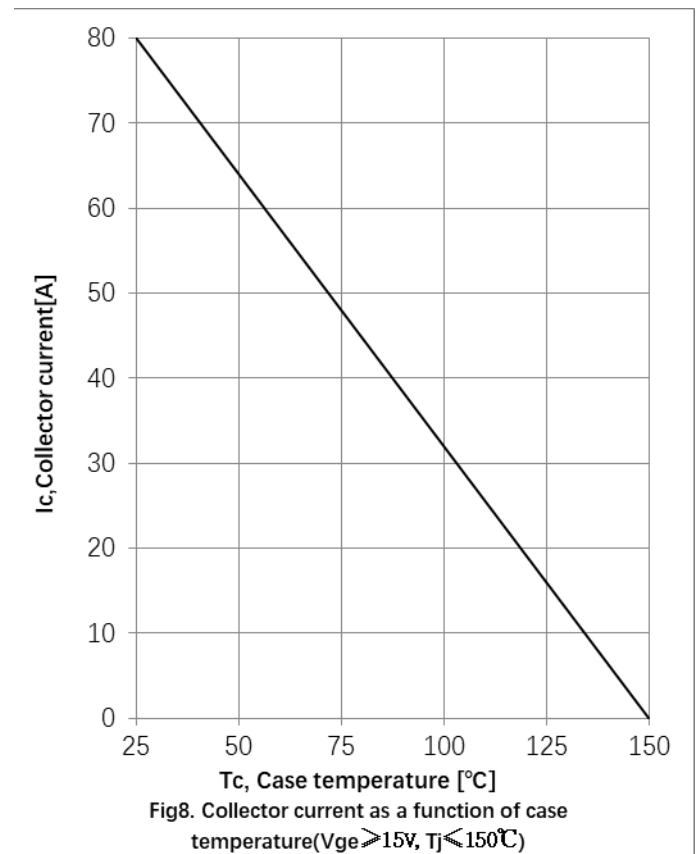
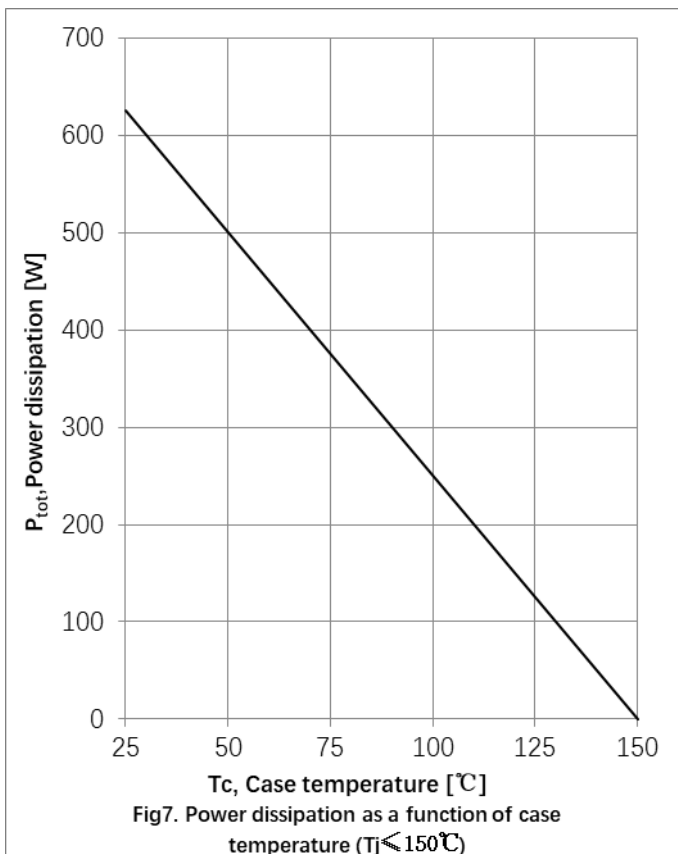
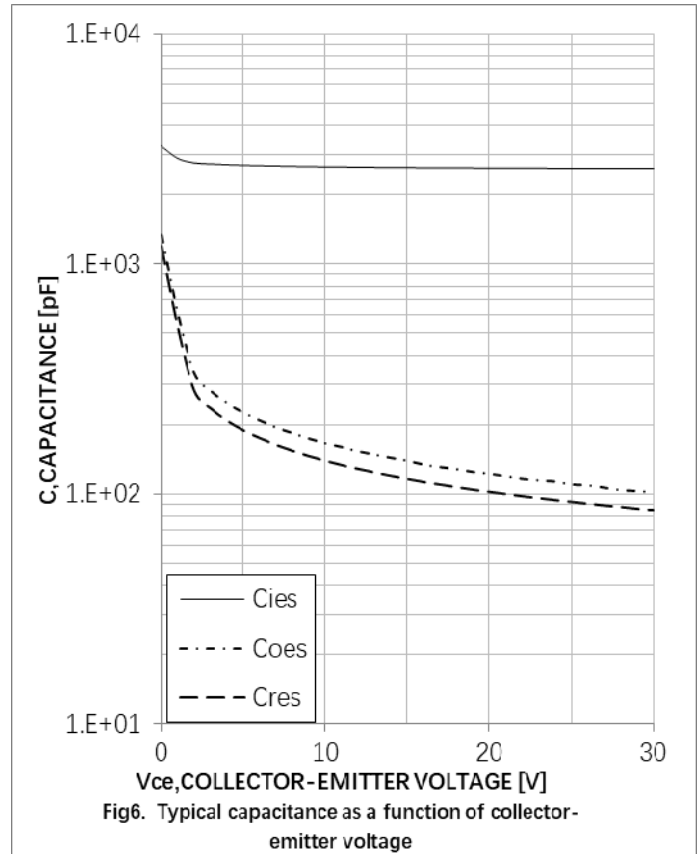
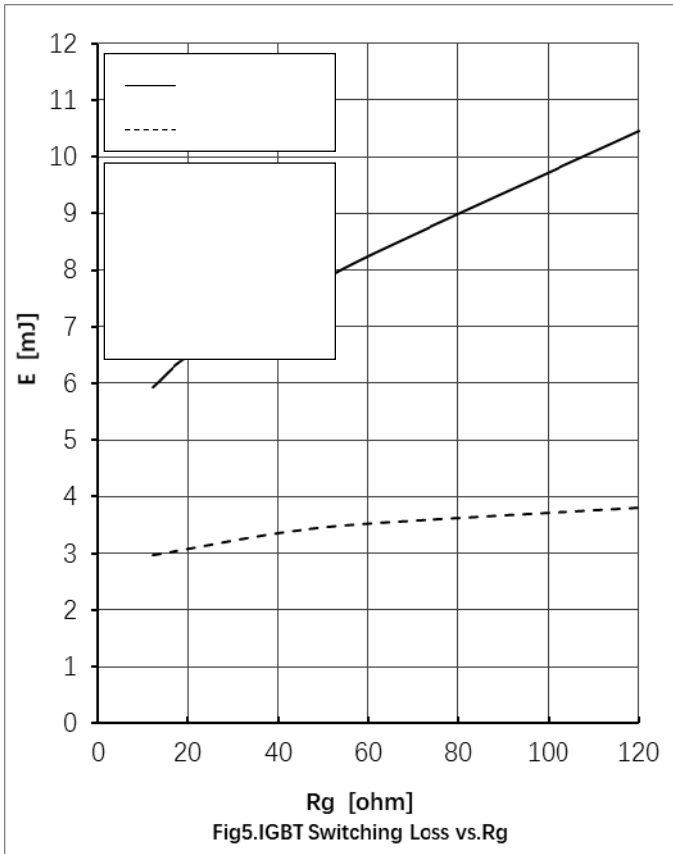
Switching Characteristic, Inductive Load

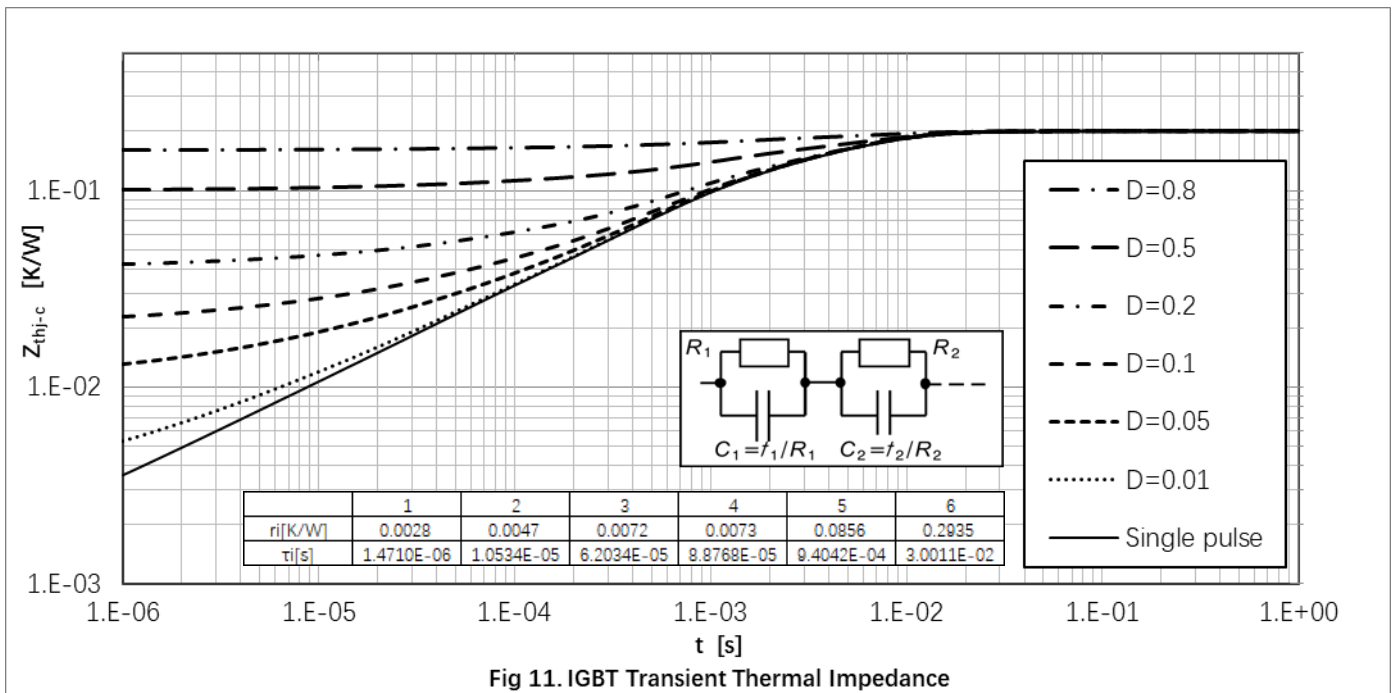
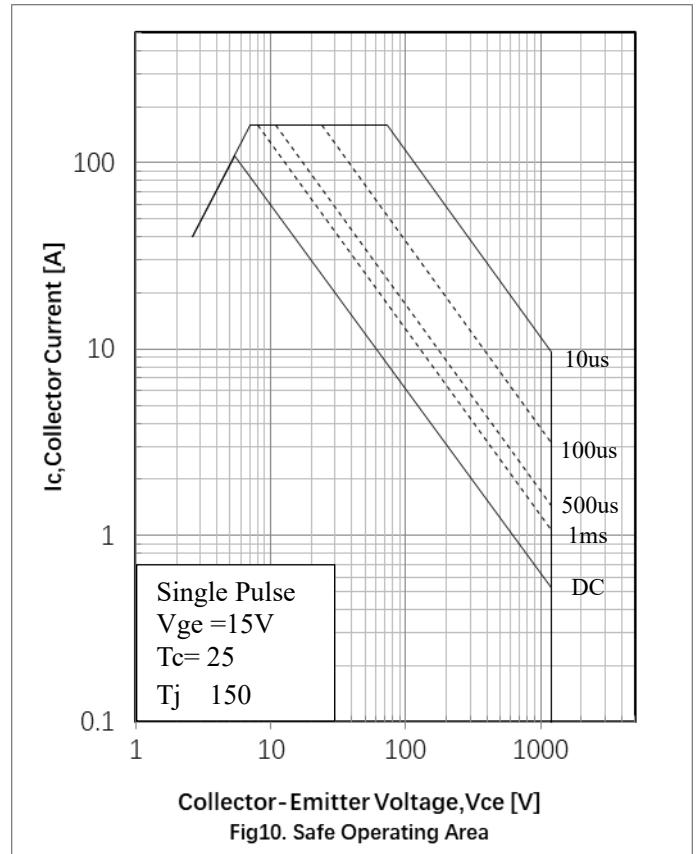
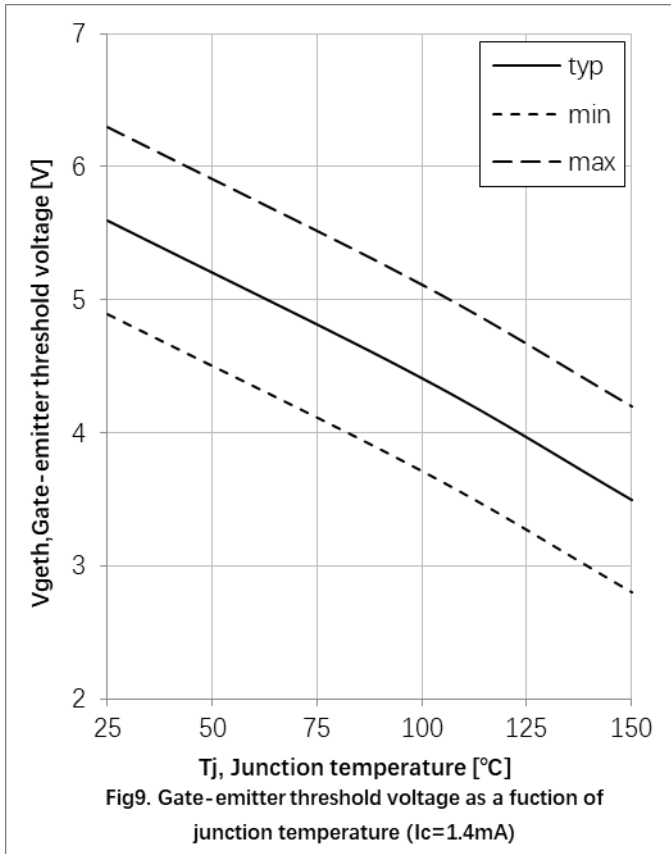
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T_j= 25						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =40A, V _{GE} = -15V~15V, R _g =12Ω	-	45	-	ns
Rise Time	t _r		-	56	-	ns
Turn-on Energy	E _{on}		-	3.8	-	mJ
Turn-off Delay Time	t _{d(off)}		-	180	-	ns
Fall Time	t _f		-	80	-	ns
Turn-off Energy	E _{off}		-	1.7	-	mJ
Dynamic , at T_j= 125						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =40A, V _{GE} = -15V~15V, R _g =12Ω	-	50	-	ns
Rise Time	t _r		-	58	-	ns
Turn-on Energy	E _{on}		-	5.4	-	mJ
Turn-off Delay Time	t _{d(off)}		-	240	-	ns
Fall Time	t _f		-	85	-	ns
Turn-off Energy	E _{off}		-	2.7	-	mJ
Dynamic , at T_j= 150						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =40A, V _{GE} = -15V~15V, R _g =12Ω	-	53	-	ns
Rise Time	t _r		-	60	-	ns
Turn-on Energy	E _{on}		-	5.8	-	mJ
Turn-off Delay Time	t _{d(off)}		-	260	-	ns
Fall Time	t _f		-	90	-	ns
Turn-off Energy	E _{off}		-	3.0	-	mJ

Thermal Resistance

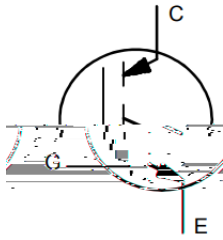
Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R _{th(j-c)}	0.20	K/W
Thermal Resistance, Junction - Ambient	R _{th(j-a)}	62	K/W



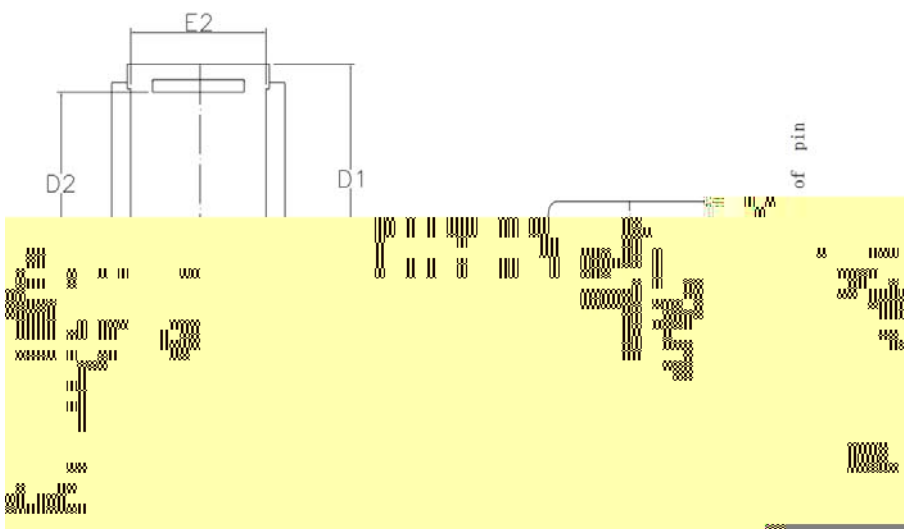
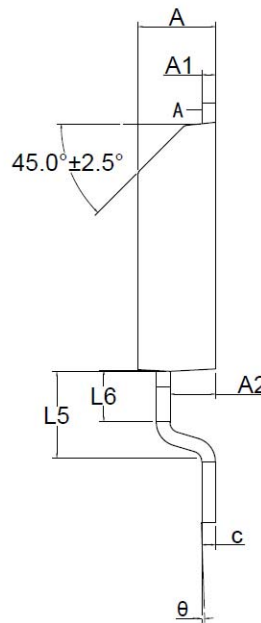
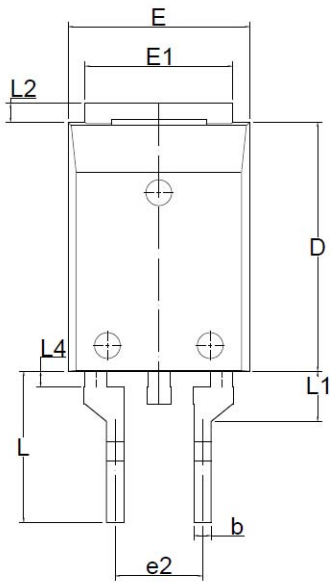




Circuit Diagram



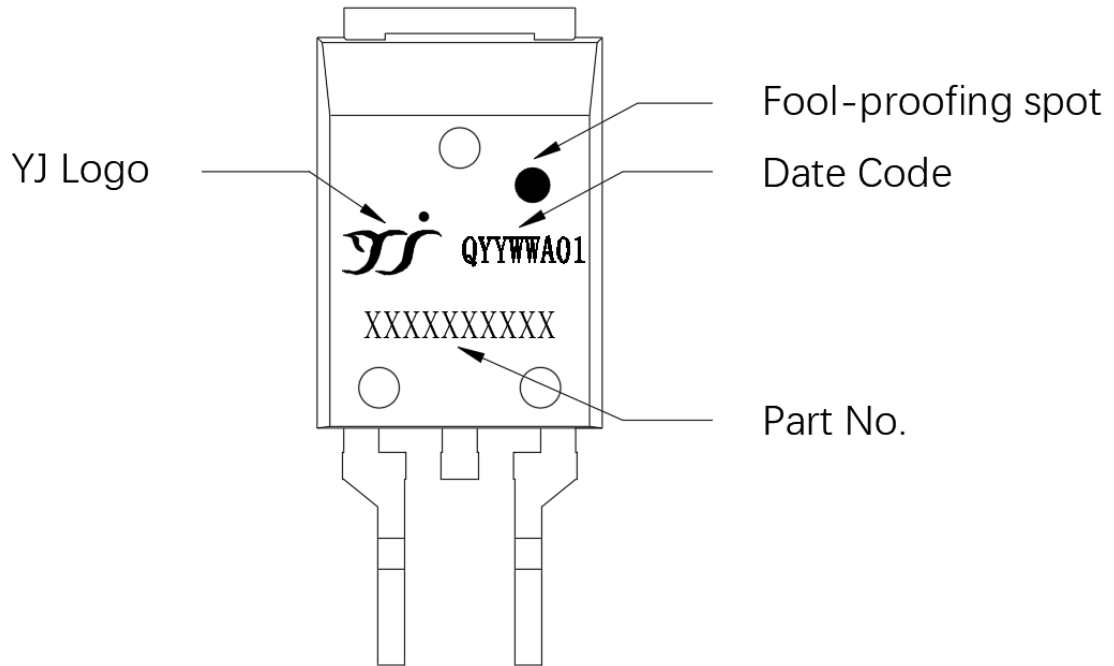
- **Package Outline Information**
CASE: STO 263



DIMENSIONS		
SYMBOL	Millimeter	
A	4.34	4.74
A1	0.70	1.00
A2	2.50	3.00
b	0.70	1.30
b1	1.25	1.65
b2	1.25	1.65
b3	2.16	2.36
c	0.70	1.00
D	14.00	15.00
D1	12.50	13.50
D2	10.54	11.54
E	10.00	11.00
E1	8.00	9.00
E2	7.70	8.70
e1	2.55 BSC	
e2	4.90	5.30
L	8.50	8.90
L1	2.65	3.15
L2	0.50	1.50
L3	1.40	2.40
L4	—	1.50
L5	5.05	5.45
L6	2.97 BSC	
θ	-2°	2°



Marking Information



Package Parameters

Base Part Number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	

